

HLMP-CBxx, HLMP-CMxx

T-1¾ (5 mm) InGaN Blue and Green LEDs



Data Sheet



Lead (Pb) Free
RoHS 6 fully
compliant



Description

This high intensity blue and green LEDs are based on the most efficient and cost effective InGaN material technology.

These LED lamps are untinted and non-diffused T-1¾ packages incorporating second generation optics producing well defined spatial radiation patterns at specific viewing cone angles.

These lamps are made with an advanced optical grade epoxy offering superior high temperature and high moisture resistance performance in outdoor signal and sign application. The epoxy contains uv inhibitor to reduce the effects of long term exposure to direct sunlight.

Features

- Viewing angle: 15°, 23° and 30°
- Well defined spatial radiation pattern
- High luminous output
- Available in Blue and Green
 - Blue 470 nm
 - Green 525 nm
- Superior resistance to moisture
- Standoff and non-standoff Package

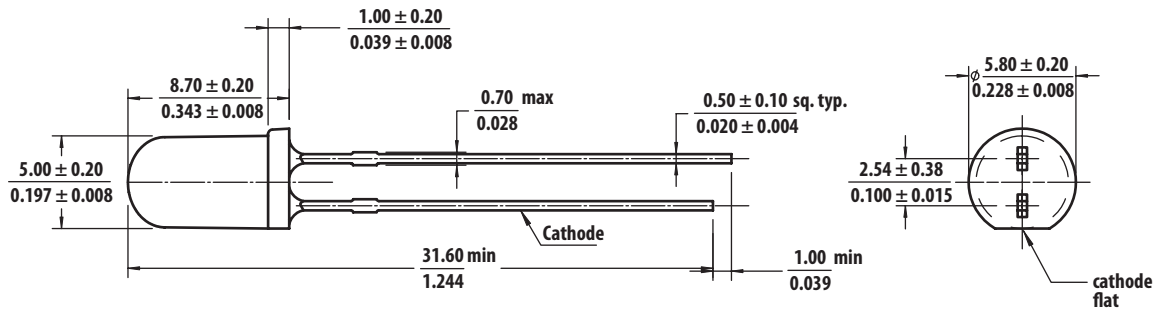
Applications

- Traffic signs
- Variable Message Sign
- Commercial outdoor advertising

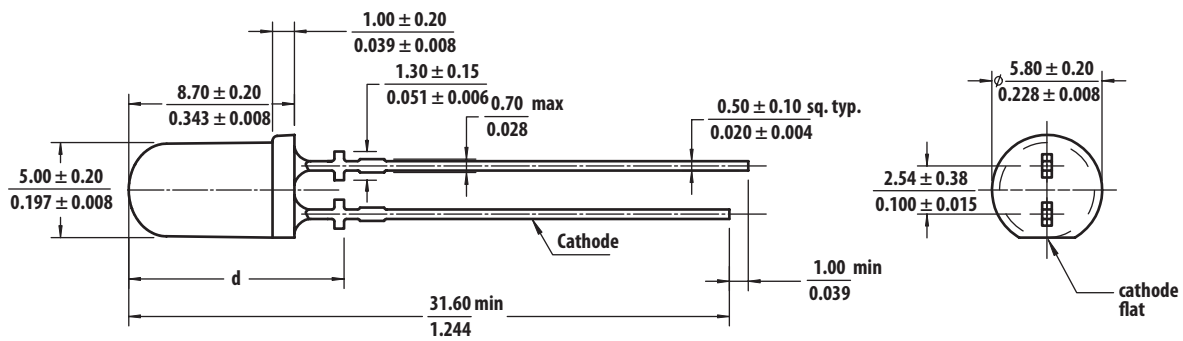
CAUTION: InGaN devices are Class 1C HBM ESD sensitive per JEDEC Standard. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.

Package Dimensions

Drawing A (Non-standoff)



Drawing B (Standoff)



Part Number	Dimension 'd'
HLMP-Cx1H	12.39 ± 0.25 mm
HLMP-Cx2H	12.35 ± 0.25 mm
HLMP-Cx3H	11.93 ± 0.25 mm

Notes:

1. All dimensions in millimeters (inches).
2. Tolerance is ± 0.20 mm unless other specified.
3. Leads are mild steel with tin plating.
4. The epoxy meniscus is 1.5 mm max.

Device Selection Guide

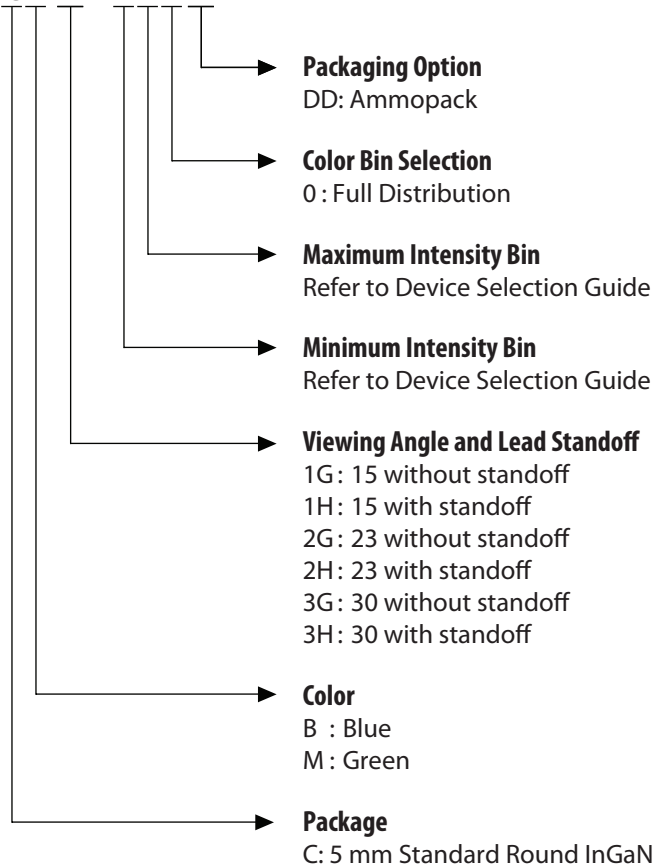
Part Number	Color and Dominant Wavelength λ_d (nm) Typ ^[3]	Luminous Intensity I _v (mcd) at 20 mA ^[1,2,5]			Typical Viewing angle (°) ^[4]
		Min	Max	Standoff	
HLMP-CB1G-WY0DD	Blue 470	5500	12000	No	15
HLMP-CB1H-WY0DD	Blue 470	5500	12000	Yes	
HLMP-CM1G-350DD	Green 525	27000	59000	No	23
HLMP-CM1H-350DD	Green 525	27000	59000	Yes	
HLMP-CB2G-UW0DD	Blue 470	3200	7200	No	23
HLMP-CB2H-UW0DD	Blue 470	3200	7200	Yes	
HLMP-CM2G-Z20DD	Green 525	12000	27000	No	30
HLMP-CM2H-Z20DD	Green 525	12000	27000	Yes	
HLMP-CB3G-TV0DD	Blue 470	2500	5500	No	30
HLMP-CB3H-TV0DD	Blue 470	2500	5500	Yes	
HLMP-CM3G-Y10DD	Green 525	9300	21000	No	30
HLMP-CM3H-Y10DD	Green 525	9300	21000	Yes	

Notes:

1. The luminous intensity is measured on the mechanical axis of the lamp package and it is tested with pulsing condition.
2. The optical axis is closely aligned with the package mechanical axis.
3. Dominant wavelength, λ_d , is derived from the CIE Chromaticity Diagram and represents the color of the lamp.
4. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is half the on-axis intensity.
5. Tolerance for each bin limit is $\pm 15\%$

Part Numbering System

HLMP - C x xx - x x x xx



Absolute Maximum Ratings

$T_J = 25^\circ\text{C}$

Parameter	Blue/Green	Unit
DC Forward Current ^[1]	30	mA
Peak Forward Current	100 ^[2]	mA
Power Dissipation	110	mW
LED Junction Temperature	110	$^\circ\text{C}$
Operating Temperature Range	-40 to +85	$^\circ\text{C}$
Storage Temperature Range	-40 to +100	$^\circ\text{C}$

Notes:

1. Derate linearly as shown in Figure 4.
2. Duty Factor 10%, frequency 1 kHz.

Electrical / Optical Characteristics

$T_J = 25^\circ\text{C}$

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Forward Voltage Blue & Green	V_F	2.8	3.1	3.6	V	$I_F = 20\text{ mA}$
Reverse Voltage ^[3] Blue & Green	V_R	5			V	$I_R = 10\ \mu\text{A}$
Dominant Wavelength ^[1] Blue Green	λ_d	460 520	470 525	480 540	nm	$I_F = 20\text{ mA}$
Peak Wavelength Blue Green	λ_{PEAK}		461 517		nm	Peak of Wavelength of Spectral Distribution at $I_F = 20\text{ mA}$
Thermal resistance	$R\theta_{J-PIN}$		240		$^\circ\text{C}/\text{W}$	LED junction to pin
Luminous Efficacy ^[2] Blue Green	η_V		68 475		lm/W	Emitted Luminous Power/ Emitted Radiant Power
Thermal coefficient of λ_d Blue Green			0.02 0.03		nm/ $^\circ\text{C}$	$I_F = 20\text{ mA};$ $+25^\circ\text{C} \leq T_J \leq +100^\circ\text{C}$

Notes:

1. The dominant wavelength is derived from the Chromaticity Diagram and represents the color of the lamp.
2. The radiant intensity, I_e in watts per steradian, maybe found from the equation $I_e = I_v / \eta_V$ where I_v is the luminous intensity in candelas and η_V is the luminous efficacy in lumens/ watt.
3. Indicates product final testing condition, long term reverse bias is not recommended.

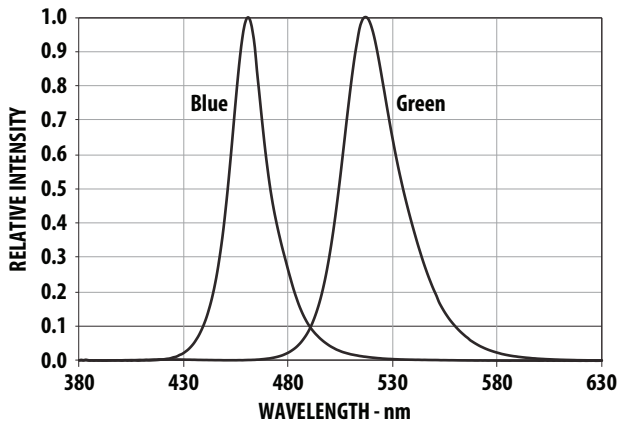


Figure 1. Relative Intensity vs Wavelength

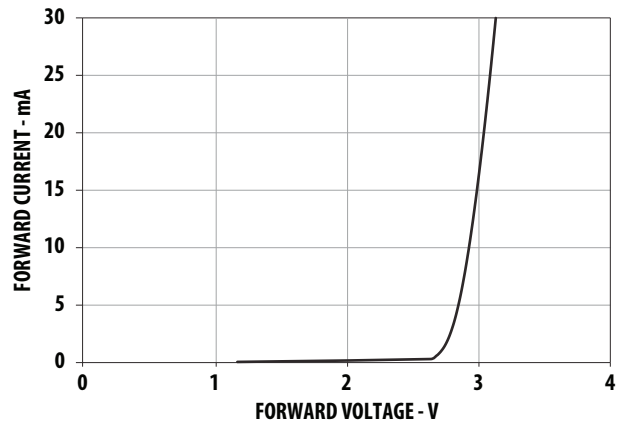


Figure 2. Forward Current vs Forward Voltage



Figure 3. Relative Intensity vs Forward Current



Figure 4. Maximum Forward Current vs Ambient Temperature



Figure 5. Relative Dominant Wavelength Shift vs Forward Current



Figure 6. Representative Radiation pattern for 15° Viewing Angle Lamp

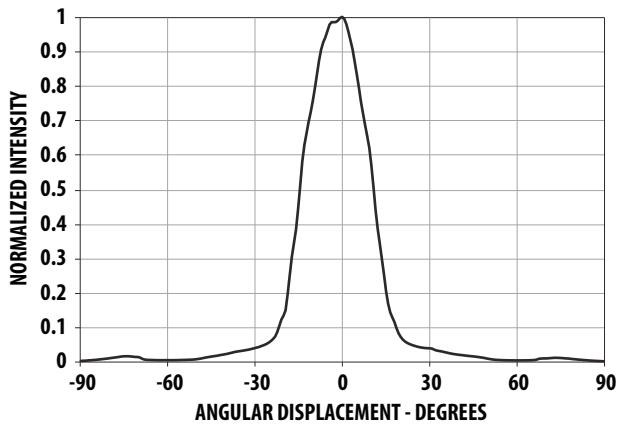


Figure 7. Representative Radiation pattern for 23° Viewing Angle Lamp

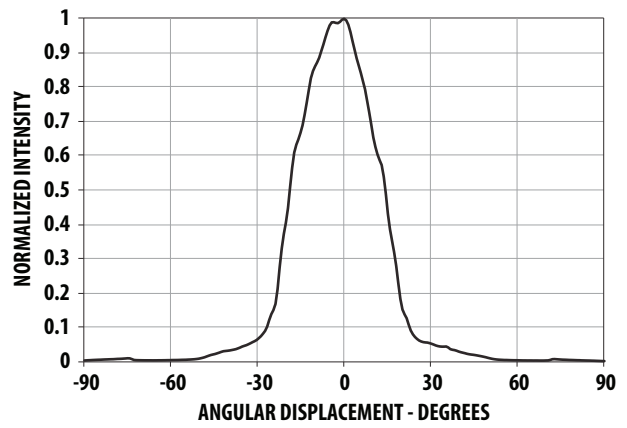


Figure 8. Representative Radiation pattern for 30° Viewing Angle Lamp



Figure 9. Relative Light Output vs Junction Temperature



Figure 10. Forward Voltage Shift vs Junction Temperature

Intensity Bin Limit Table (1.3 : 1 Iv Bin Ratio)

Bin	Intensity (mcd) at 20 mA	
	Min	Max
T	2500	3200
U	3200	4200
V	4200	5500
W	5500	7200
X	7200	9300
Y	9300	12000
Z	12000	16000
1	16000	21000
2	21000	27000
3	27000	35000
4	35000	45000
5	45000	59000

Tolerance for each bin limit is $\pm 15\%$

Green Color Bin Table

Bin	Min Dom	Max Dom	Xmin	Ymin	Xmax	Ymax
1	520.0	524.0	0.0743	0.8338	0.1856	0.6556
			0.1650	0.6586	0.1060	0.8292
2	524.0	528.0	0.1060	0.8292	0.2068	0.6463
			0.1856	0.6556	0.1387	0.8148
3	528.0	532.0	0.1387	0.8148	0.2273	0.6344
			0.2068	0.6463	0.1702	0.7965
4	532.0	536.0	0.1702	0.7965	0.2469	0.6213
			0.2273	0.6344	0.2003	0.7764
5	536.0	540.0	0.2003	0.7764	0.2659	0.6070
			0.2469	0.6213	0.2296	0.7543

Tolerance for each bin limit is ± 0.5 nm.

Blue Color Bin Table

Bin	Min Dom	Max Dom	Xmin	Ymin	Xmax	Ymax
1	460.0	464.0	0.1440	0.0297	0.1766	0.0966
			0.1818	0.0904	0.1374	0.0374
2	464.0	468.0	0.1374	0.0374	0.1699	0.1062
			0.1766	0.0966	0.1291	0.0495
3	468.0	472.0	0.1291	0.0495	0.1616	0.1209
			0.1699	0.1062	0.1187	0.0671
4	472.0	476.0	0.1187	0.0671	0.1517	0.1423
			0.1616	0.1209	0.1063	0.0945
5	476.0	480.0	0.1063	0.0945	0.1397	0.1728
			0.1517	0.1423	0.0913	0.1327

Tolerance for each bin limit is ± 0.5 nm

Note:

- All bin categories are established for classification of products. Products may not be available in all bin categories. Please contact your Avago representative for further information.

Avago Color Bin on CIE 1931 Chromaticity Diagram



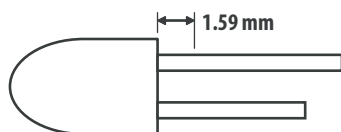
Precautions:

Lead Forming:

- The leads of an LED lamp may be preformed or cut to length prior to insertion and soldering on PC board.
- For better control, it is recommended to use proper tool to precisely form and cut the leads to applicable length rather than doing it manually.
- If manual lead cutting is necessary, cut the leads after the soldering process. The solder connection forms a mechanical ground which prevents mechanical stress due to lead cutting from traveling into LED package. This is highly recommended for hand solder operation, as the excess lead length also acts as small heat sink.

Soldering and Handling:

- Care must be taken during PCB assembly and soldering process to prevent damage to the LED component.
- LED component may be effectively hand soldered to PCB. However, it is only recommended under unavoidable circumstances such as rework. The closest manual soldering distance of the soldering heat source (soldering iron's tip) to the body is 1.59mm. Soldering the LED using soldering iron tip closer than 1.59mm might damage the LED.
- ESD precaution must be properly applied on the



soldering station and personnel to prevent ESD damage to the LED component that is ESD sensitive. Do refer to Avago application note AN 1142 for details. The soldering iron used should have grounded tip to ensure electrostatic charge is properly grounded.

- Recommended soldering condition:

	Wave Soldering [1, 2]	Manual Solder Dipping
Pre-heat temperature	105° C Max.	–
Preheat time	60 sec Max	–
Peak temperature	260° C Max.	260° C Max.
Dwell time	5 sec Max.	5 sec Max

Note:

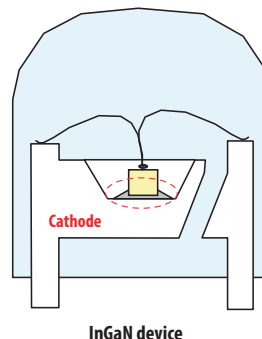
1. Above conditions refers to measurement with thermocouple mounted at the bottom of PCB.
2. It is recommended to use only bottom preheaters in order to reduce thermal stress experienced by LED.

- Wave soldering parameters must be set and maintained according to the recommended temperature and dwell time. Customer is advised to perform daily check on the soldering profile to ensure that it is always conforming to recommended soldering conditions.

Note:

1. PCB with different size and design (component density) will have different heat mass (heat capacity). This might cause a change in temperature experienced by the board if same wave soldering setting is used. So, it is recommended to re-calibrate the soldering profile again before loading a new type of PCB.

Avago Technologies LED Configuration



- Any alignment fixture that is being applied during wave soldering should be loosely fitted and should not apply weight or force on LED. Non metal material is recommended as it will absorb less heat during wave soldering process.
- At elevated temperature, LED is more susceptible to mechanical stress. Therefore, PCB must allowed to cool down to room temperature prior to handling, which includes removal of alignment fixture or pallet.
- If PCB board contains both through hole (TH) LED and other surface mount components, it is recommended that surface mount components be soldered on the top side of the PCB. If surface mount need to be on the bottom side, these components should be soldered using reflow soldering prior to insertion the TH LED.
- Recommended PC board plated through holes (PTH) size for LED component leads.

LED component lead size	Diagonal	Plated through hole diameter
0.45 x 0.45 mm (0.018 x 0.018 inch)	0.636 mm (0.025 inch)	0.98 to 1.08 mm (0.039 to 0.043 inch)
0.50 x 0.50 mm (0.020 x 0.020 inch)	0.707 mm (0.028 inch)	1.05 to 1.15 mm (0.041 to 0.045 inch)

- Over-sizing the PTH can lead to twisted LED after clinching. On the other hand under sizing the PTH can cause difficulty inserting the TH LED.

Refer to application note AN5334 for more information about soldering and handling of high brightness TH LED lamps.

Example of Wave Soldering Temperature Profile for TH LED



Recommended solder:
 Sn63 (Leaded solder alloy)
 SAC305 (Lead free solder alloy)

Flux: Rosin flux

Solder bath temperature: $255^{\circ}\text{C} \pm 5^{\circ}\text{C}$
 (maximum peak temperature = 260°C)

Dwell time: 3.0 sec - 5.0 sec
 (maximum = 5sec)

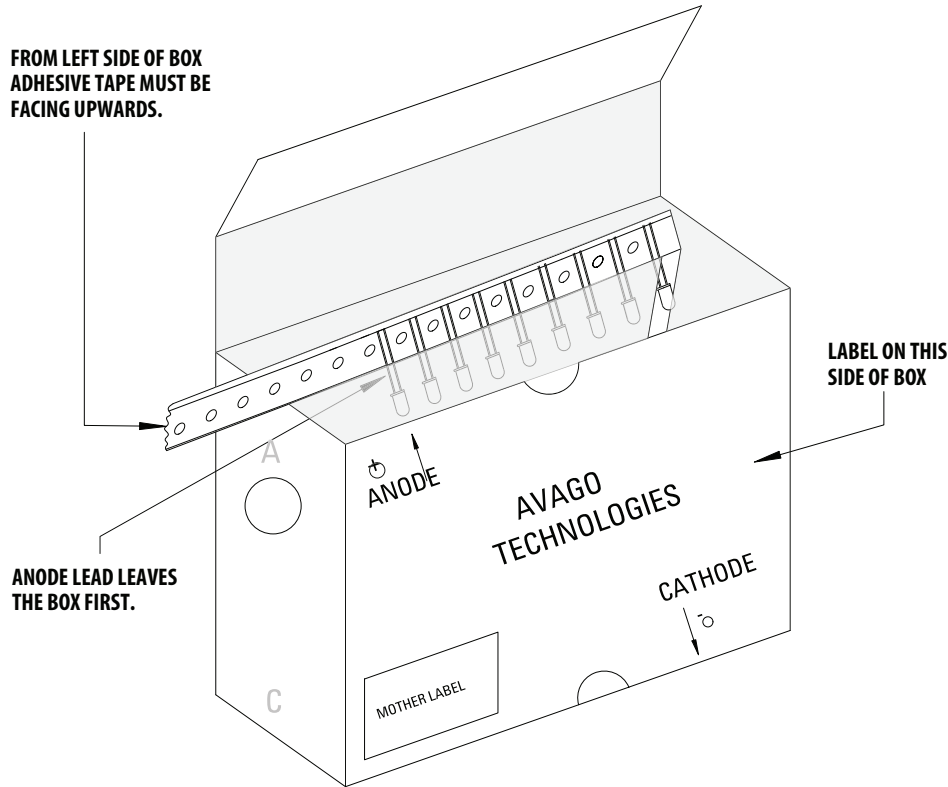
Note: Allow for board to be sufficiently cooled to room temperature before exerting mechanical force.

Ammo Packs Drawing



Note: The ammo-packs drawing is applicable for packaging option -DD & -ZZ and regardless standoff or non-standoff

Packaging Box for Ammo Packs










Note: For InGaN device, the ammo pack packaging box contain ESD logo

Packaging Label

(i) Avago Mother Label: (Available on packaging box of ammo pack and shipping box)

AVAGO TECHNOLOGIES	
STANDARD LABEL LS0002	
RoHS Compliant	
e3 max temp 260C	
(1P) Item: Part Number	(Q) QTY: Quantity
(1T) Lot: Lot Number	CAT: Intensity Bin
LPN:	BIN: Color Bin
(9D)MFG Date: Manufacturing Date	
<hr/>	
(P) Customer Item:	
(V) Vendor ID:	(9D) Date Code: Date Code
<hr/>	
DeptID:	Made In: Country of Origin

(ii) Avago Baby Label (Only available on bulk packaging)

		RoHS Compliant	
Lamps Baby Label		e3 max temp 260C	
(1P) PART #: Part Number			
(1T) LOT #: Lot Number			
(9D)MFG DATE: Manufacturing Date	QUANTITY: Packing Quantity		
C/O: Country of Origin			
Customer P/N:	CAT: Intensity Bin		
Supplier Code:	BIN: Color Bin		
	DATECODE: Date Code		

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